

#### AMP-LATCH | AMP-LATCH Universal Headers

TE Internal #: 5102153-5

Wire-to-Board, 24 Position, 2.54 mm [.1 in] Centerline, Vertical,

Through Hole - Solder, 2 Row, AMP-LATCH Universal Headers,

Ribbon Cable Connectors

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Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors > AMP-LATCH UNIVERSAL HEADERS











Connector System: Wire-to-Board

Number of Positions: 24

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Retention: Without
PCB Mount Orientation: Vertical

All AMP-LATCH UNIVERSAL HEADERS (523)

# **Features**

# **Product Type Features**

| Connector Product Type             | Connector Assembly             |
|------------------------------------|--------------------------------|
| Ribbon Cable Connector Header Type | Universal Ejection Pin Headers |
| Connector System                   | Wire-to-Board                  |
| Connector & Housing Type           | Plug                           |
| Connector & Contact Terminates To  | Printed Circuit Board          |

# **Configuration Features**

| Number of Positions   | 24       |
|-----------------------|----------|
| PCB Mount Orientation | Vertical |
| Number of Rows        | 2        |

# **Electrical Characteristics**

| Operating Voltage     | 250 VAC |
|-----------------------|---------|
| Insulation Resistance | 5000 MΩ |



# **Body Features**

| Primary Product Color                                   | Black                                      |  |
|---|--|--|
| Connector Profile                                       | Standard                                   |  |
| Contact Features  |  |  |
| Contact Underplating Material                           | Nickel                                     |  |
|   | 15 μin                                     |  |
| Mating Square Post Dimension                            | .64 mm[.025 in]                            |  |
| Contact Shape & Form                                    | Square                                     |  |
| PCB Contact Termination Area Plating Material Thickness | 2.54 μm[100 μin]                           |  |
| Contact Mating Area Plating Material                    | Gold (Au), Gold Flash over Palladium Nicke |  |
| Contact Base Material                                   | Phosphor Bronze                            |  |
| PCB Contact Termination Area Plating Material           | Tin  |  |
| Contact Type  | Pin  |  |
| Contact Current Rating (Max)                            | 1 A  |  |
| Termination Features                                    |  |  |
| Termination Post & Tail Diameter                        | .64 mm[.025 in]                            |  |
| Termination Post & Tail Length                          | 2.79 mm[.11 in]                            |  |
| Termination Method to PCB                               | Through Hole - Solder                      |  |
| Mechanical Attachment                                   |  |  |
| Panel Mount Feature                                     | Without                                    |  |
| Mating Alignment  | With                                       |  |
| PCB Mount Alignment                                     | Without                                    |  |
| PCB Mount Retention                                     | Without                                    |  |
|   |  |  |

Mating Alignment Type Center, Dual Polarizing Bar

Mating Retention With

Mating Retention Type Ejection Latch

**Board Mount** Connector Mounting Type

# **Housing Features**

| Mating Entry Location | Тор            |
|-----------------------|----------------|
| Housing Material      | Nylon - GF     |
| Centerline (Pitch)    | 2.54 mm[.1 in] |

### **Dimensions**



| Shrouded End Dimension      | 3.81 mm[.15 in]   |  |
|-----------------------------|-------------------|--|
| PCB Thickness (Recommended) | 1.57 mm[.062 in]  |  |
| Connector Height            | 13.94 mm[.55 in]  |  |
| Connector Length            | 49.78 mm[1.96 in] |  |
| Row-to-Row Spacing          | 2.54 mm[.1 in]    |  |
| Usage Conditions            |                   |  |

| Housing Temperature Rating  | High                       |
|-----------------------------|----------------------------|
| Operating Temperature Range | -65 – 105 °C[-85 – 221 °F] |

# Operation/Application

| Circuit Ap  | oplication      | Signal   |
|-------------|-----------------|----------|
| Industry St | andards         |          |
| UL Flamn    | nability Rating | UL 94V-0 |

# **Packaging Features**

| Packaging Quantity | 60   |
|--------------------|------|
| Packaging Method   | Tray |

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU                  | Compliant   |
|---|---|
| EU ELV Directive 2000/53/EC                   | Compliant   |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold   |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JAN 2025<br>(247)<br>Candidate List Declared Against: JAN 2025<br>(247)<br>Does not contain REACH SVHC |
| Halogen Content                               | Not Low Halogen - contains Br or Cl > 900 ppm.  |
| Solder Process Capability                     | Wave solder capable to 265°C  |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous



materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**





24 NOVO MIL 30DP, LEAD FREE





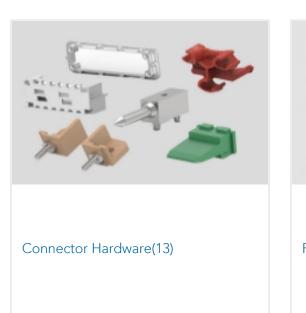


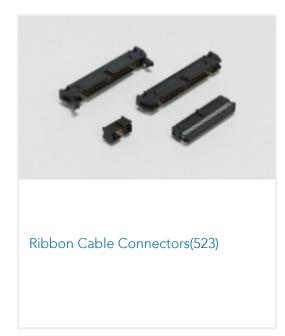






# Also in the Series | AMP-LATCH Universal Headers

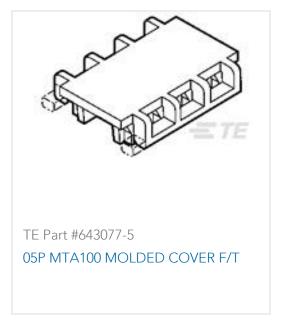




# Customers Also Bought







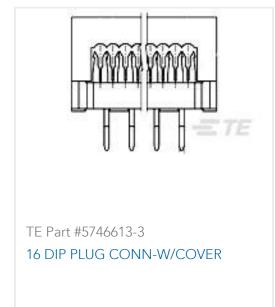












# **Documents**

# **Product Drawings**

A/L UNIV HDR 24P VERT

English

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_5102153-5\_B.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5102153-5\_B.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5102153-5\_B.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

# Datasheets & Catalog Pages

Ribbon Cable Interconnect Solutions

English

# **Product Specifications**

**Product Specification** 

English

# **Agency Approvals**

**Agency Approval Document** 

English